



Global Communication Semiconductors, LLC

Corporate & Foundry

23155 Kashiwa Court, Torrance, CA. 90505

Telephone: 310-530-7274 Fax: 310-517-8200

Website: www.gcsincorp.com

Job Title: **Process Engineer**
Job Req: #0606
Department: Manufacturing Engineering
Status: Full-Time/Exempt
Shift: Day

Job Description

- Supports production, sustains production processes, develops new processes and implements process improvements in the backside processing areas, including wafer bonding, thinning, polishing, as well as backside via etch, metallization, wafer demount and cleaning
- Resolves process issues and dispositions production on hold in responsible module
- Works closely with other module engineers on process issues for continuous production flow

Job Requirements

- B.S degree in engineering or related field
- Familiarity with compound semiconductor processing is desirable
- Hands-on experience in semiconductor processing equipment and metrology tools
- Knowledge in wafer grinding or wafer thinning a plus
- Basic Excel and document drafting skills
- Excellent written and communication skills
- Must be well organized and detail oriented